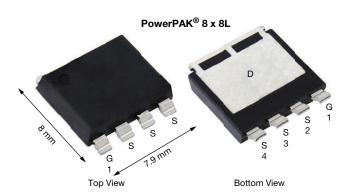


www.vishay.com

Vishay Siliconix

Automotive N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	80			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0014			
I _D (A)	430			
Configuration	Single			
Package	PowerPAK 8 x 8L			

FEATURES

- TrenchFET® Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Thin 1.6 mm height
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



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N-Channel MOSFET	

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unles	s otherwise noted	l)	
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	80	V
Gate-source voltage		V_{GS}	± 20	V
Continuous drain current	T _C = 25 °C		430	
Continuous drain current	T _C = 125 °C	l _D	250	
Continuous source current (diode conduction)		I _S	450	Α
Pulsed drain current ^a		I _{DM}	1200	
Single pulse avalanche current	1 04		65	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	211	mJ
Maximum power dissipation	T _C = 25 °C	D	600	10/
	T _C = 125 °C	P_{D}	200	W
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) ^c			260	C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount b	R _{thJA}	40	°C/W
Junction-to-case (drain)		R _{thJC}	0.25	C/VV

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. When mounted on 1" square PCB (FR4 material)
- c. See solder profile (www.vishay.com/doc?73257). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	80	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		3	3.5	1 V	
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA	
		V _{GS} = 0 V	V _{DS} = 80 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 125 °C	-	-	50	μΑ	
		$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 175 °C	-	-	500		
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 \text{ V}$	$V_{DS} \ge 5 V$	50	-	-	Α	
		$V_{GS} = 10 \text{ V}$	$I_D = 20 \text{ A}$	-	0.0011	0.0014		
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	I _D = 20 A, T _J = 125 °C	-	-	0.0026	Ω	
		$V_{GS} = 10 \text{ V}$	I _D = 20 A, T _J = 175 °C	-	-	0.0033		
Forward transconductance b	9 _{fs}	V_{DS}	= 15 V, I _D = 15 A	-	82	-	S	
Dynamic ^b								
Input capacitance	C _{iss}			-	11 435	16 010		
Output capacitance	Coss	$V_{GS} = 0 V$	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	-	1896	2655	pF	
Reverse transfer capacitance	C _{rss}			-	92	130		
Total gate charge ^c	Q_g			-	181	272		
Gate-source charge ^c	Q_{gs}	$V_{GS} = 10 \text{ V}$	$V_{DS} = 40 \text{ V}, I_D = 50 \text{ A}$	-	51	-	nC	
Gate-drain charge ^c	Q_{gd}			-	36	-		
Gate resistance	R_g	f = 1 MHz		0.7	1.3	2	Ω	
Turn-on delay time ^c	t _{d(on)}			-	21	28		
Rise time ^c	t _r		$40 \text{ V}, R_L = 0.8 \Omega,$	-	80	105	ns	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		-	65	85	115	
Fall time ^c	t _f			-	20	28		
Source-Drain Diode Ratings and Character	teristics ^b							
Pulsed current ^a	I _{SM}			-	-	1100	Α	
Forward voltage	V_{SD}	I _F =	$40 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.7	1.2	V	
Body diode reverse recovery time	t _{rr}			-	72	144	ns	
Body diode reverse recovery charge	Q _{rr}	1000/		-	143	286	nC	
Reverse recovery fall time	t _a	I _F = 10 A, di/dt = 100 A/μs		-	41	-		
Reverse recovery rise time	t _b			-	30	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			_	3.5	_	Α	

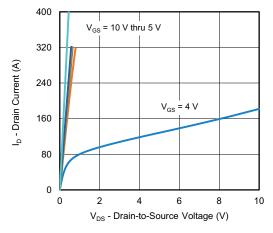
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

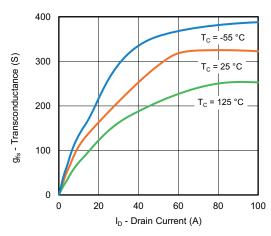
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



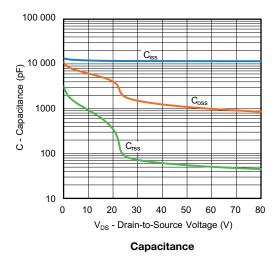
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

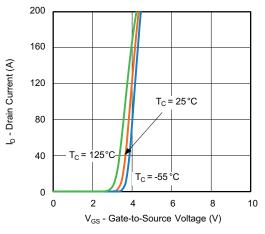


Output Characteristics

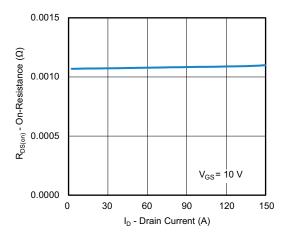


Transconductance

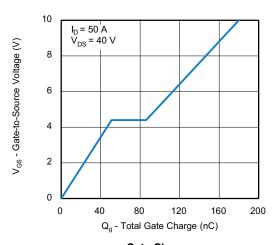




Transfer Characteristics



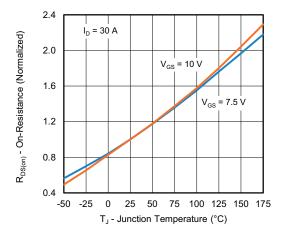
On-Resistance vs. Drain Current



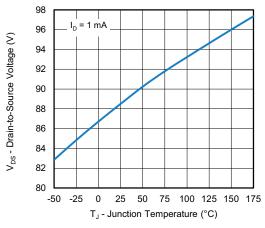
Gate Charge



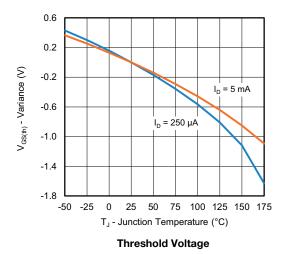
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

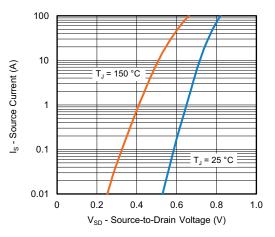


On-Resistance vs. Junction Temperature

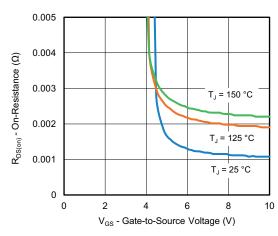


Drain Source Breakdown vs. Junction Temperature

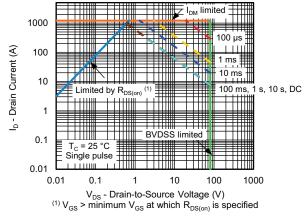




Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Safe Operating Area

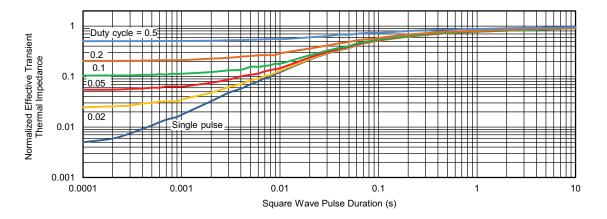
Note

a. $V_{GS} > minimum V_{GS}$ at which $R_{DS(on)}$ is specified

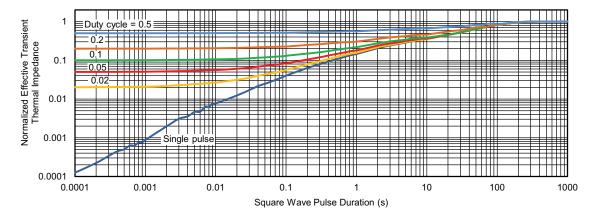
For technical questions, contact: automostechsu



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



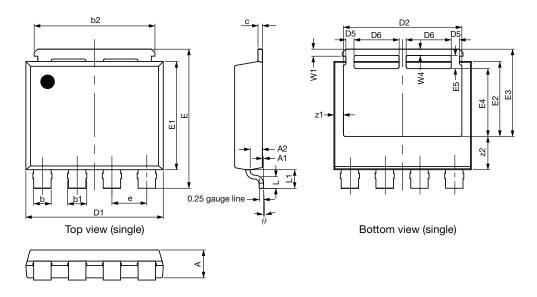
Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77102.



www.vishay.com

PowerPAK® 8 x 8L BWL Case Outline 2



DIM	MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	1.50	1.60	1.70	0.059	0.063	0.067
A1	0.00	-	0.127	0.000	-	0.005
A2	0.655	0.705	0.755	0.026	0.028	0.030
b	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	6.84	6.94	7.04	0.269	0.273	0.277
С	0.20	0.25	0.30	0.008	0.010	0.012
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
е	1.97	2.00	2.03	0.078	0.079	0.080
E	7.90	8.00	8.10	0.311	0.315	0.319
E1	6.12	6.22	6.32	0.241	0.245	0.249
E2	4.21	4.31	4.41	0.166	0.170	0.174
E3	4.92	5.02	5.12	0.194	0.198	0.202
E4	3.80	3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033
L	0.61	0.68	0.75	0.024	0.027	0.030
L1	1.00	1.07	1.15	0.039	0.042	0.045
W1	0.30	0.40	0.50	0.012	0.016	0.020
W4	0.32	0.37	0.42	0.013	0.015	0.017
z1	0.45	0.55	0.65	0.018	0.022	0.026
z2	1.81	1.91	2.01	0.071	0.075	0.079
θ	0°	-	5°	0°	-	5°

ECN: S19-0643-Rev. B, 05-Aug-2019

DWG: 6073

Note

Millimeter will govern

Revison: 05-Aug-2019 1 Document Number: 79736



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